

## Electronic Patent Application Fee Transmittal

Application Number:	10622915			
Filing Date:	18-Jul-2003			
Title of Invention:	METHODS OF FORMING INTEGRATED CIRCUIT DEVICES INCLUDING A MULTI-LAYER POLY FILM CELL PAD CONTACT HOLE			
First Named Inventor/Applicant Name:	Yong-Chul Oh			
Filer:	Robert W. Glatz/Carey Gregory			
Attorney Docket Number:	5649-1142			
Filed as Large Entity				
<b>Utility Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Request for continued examination	1801	1	790	790
<b>Total in USD (\$)</b>				<b>790</b>